

41  
TS00-563



2823  
January 25, 2004

TO: Commissioner of Patents  
P.O. Box 1450  
Alexandria VA 22313-1450

FROM: Stephen Ackerman Reg. No. 37,761  
28 Davis Avenue  
Poughkeepsie, N.Y. 12603

SUBJECT: Serial # 09/863,224 File Date: 05/24/2001  
Inventor: Ming-Hsing Tsai  
Examiner: Neal Berezny  
Art Unit: 2823  
Title: A Method To Solve Via Poisoning For Porous Low-K Dielectric

#### RESPONSE TO OFFICE ACTION

This is in response to the Final Office Action dated 01/12/2004. Please amend the above identified application for patent as follows:

#### CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to :  
Commissioner of Patents P.O. Box 1450 Alexandria VA 22313-1450 on

April 12, 2004

Signature  Date: \_\_\_\_\_  
Stephen B. Ackerman, Reg. No. 37,761

4/12, 2004



TSMC-563

Application No. : 09/863,224  
Inventor : Ming-Hsing Tsai  
File Date : 05/24/2001  
Art Unit : 2823  
Examiner : Neal Berezny

Confirmation No. \_\_\_\_\_

Docket No. : TSMC 00-085  
Customer No. : \_\_\_\_\_

Commissioner of Patents  
P.O. Box 1450  
Alexandria VA 22313-1450

### AMENDMENT

Sir:

In response to the Office Action of 01/12/2004, please amend the above-identified application as follows:

**Amendments to the Claims** are reflected in the listing of claims which begins on page 3 of the paper.

**Remarks/Arguments** begin on page 11 of this paper.